PRODUCT FAMILY DATA SHEET

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Cree® XLamp® XQ-A LEDs









PRODUCT DESCRIPTION

The XLamp® XQ-A LED brings a mid-power, cost-effective option to the proven, compact ceramic XQ package, enabling lighting manufacturers to quickly and easily expand their product portfolio by leveraging a common XQ design. Unlike plastic mid-power LEDs, the ceramic-based XQ-A LEDs are designed to deliver the long-term calculated lifetimes of Cree's other high-power LEDs. The XQ-A LED's combination of optical symmetry and consistency across all colors improves color mixing and simplifies the production process for lighting manufacturers. Available in both white and color configurations, the XQ-A LED family opens up new design possibilities for a wide spectrum of lighting applications, such as portable, directional, architectural and vehicle lighting.

FEATURES

- Cree's smallest lighting class LED:
 1.6 X 1.6 mm
- Available in 70-, 80- & 90-CRI white, and royal blue, blue, green, PC amber, red-orange & red
- Maximum drive current: white: 300 mA, color: 250 mA
- Wide viewing angle: white: 100°, royal blue, blue, PC amber: 105°, green, red-orange, red: 110°
- Reflow solderable JEDEC J-STD-020C compatible
- Unlimited floor life at
 ≤ 30 °C/85% RH
- · RoHS-compliant
- UL® recognized component (E349212)



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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white	°C/W		20	
Thermal resistance, junction to solder point - royal blue, blue	°C/W		17	
Thermal resistance, junction to solder point - green	°C/W		30	
Thermal resistance, junction to solder point - PC amber	°C/W		20	
Thermal resistance, junction to solder point - red-orange, red	°C/W		18	
Viewing angle (FWHM) - white	degrees		100	
Viewing angle (FWHM) - royal blue, blue, PC amber	degrees		105	
Viewing angle (FWHM) - green, red-orange, red	degrees		110	
Temperature coefficient of voltage - white	mV/°C		-2.8	
Temperature coefficient of voltage - royal blue, blue	mV/°C		-4	
Temperature coefficient of voltage - green	mV/°C		-4.3	
Temperature coefficient of voltage - PC amber	mV/°C		-4.2	
Temperature coefficient of voltage - red-orange, red	mV/°C		-2.0	
ESD withstand voltage (HBM per Mil-Std-883D) - white, royal blue, blue, green, red-orange, red			Class 3A	
ESD classification (HBM per Mil-Std-883D) - PC amber			Class 2	
DC forward current-white	mA			300
DC forward current - color	mA			250
Reverse voltage	V			5
Forward voltage (@ 175 mA, 85 °C) - white	V		3.0	3.3
Forward voltage (@ 175 mA, 25 °C) - royal blue, blue	V		3.25	3.6
Forward voltage (@ 175 mA, 25 °C) - green	V		3.4	3.6
Forward voltage (@ 175 mA, 25 °C) - PC amber	V		3.4	3.7
Forward voltage (@ 175 mA, 25 °C) - red-orange, red	V		2.2	2.6
LED junction temperature	°C			150



FLUX CHARACTERISTICS - WHITE (T, = 85 °C)

The following table provides several base order codes for XLamp XQ-A white LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XQ Family LEDs Binning and Labeling document.

CCT Ra Color		Range	Minimum	Luminous Flux	@ 175 mA	Calculated Minimum Luminous Flux (Im) @ 85 °C**	Order Code		
	Minimum	Maximum	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	300 mA			
			M3	45.7	52.6	65.6	XQAAWT-00-0000-00000L3E2		
Cool White	5000 K	8300 K	N2	51.7	59.5	74.2	XQAAWT-00-0000-00000L4E2		
			N3	56.8	65.3	81.6	XQAAWT-00-0000-00000L5E2		
70-CRI					M3	45.7	52.6	65.6	XQAAWT-00-0000-00000B3E2
Minimum White	3700 K	8300 K	N2	51.7	59.5	74.2	XQAAWT-00-0000-00000B4E2		
white			N3	56.8	65.3	81.6	XQAAWT-00-0000-00000B5E2		
Neutral	3700 K	5300 K	M2	39.8	45.8	57.1	XQAAWT-00-0000-00000L2E4		
White	3700 K	5300 K	M3	45.7	52.6	65.6	XQAAWT-00-0000-00000L3E4		
Warm White	2700 K	2500 K	K3	35.2	40.5	50.5	XQAAWT-00-0000-00000LZE7		
warm white	2700 K	3500 K	M2	39.8	45.8	57.1	XQAAWT-00-0000-00000L2E7		
80-CRI Minimum	2700 K	3500 K	K3	35.2	40.5	50.5	XQAAWT-00-0000-00000HZE7		
White	2/00 K		M2	39.8	45.8	57.1	XQAAWT-00-0000-00000H2E7		
90-CRI Minimum	2850 K	3000 K	J2	23.5	26.6	37.3	XQAAWT-00-0000-00000UYE7		
White	2030 K	3000 K	K2	30.6	35.2	43.9	XQAAWT-00-0000-00000UZE7		

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 15).
- Typical CRI for Cool White (5000 K 8300 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- Minimum CRI for 70-CRI Minimum White is 70.
- Minimum CRI for 80-CRI Minimum White is 80.
- Minimum CRI for 90-CRI Minimum White is 90.
- * Flux values @ 25 °C are calculated and for reference only.
- ** Calculated flux values at 350 mA are for reference only.



FLUX CHARACTERISTICS - COLOR (T_J = 25 °C)

The following table provides several base order codes for XLamp XQ-A color LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XQ Family LEDs Binning and Labeling document.

	Do	minant Wav	elength Rar	nge	Minimum Padian	+ Elux @ 17E mA	
Color	Minimum		Maximum		Minimum Radiant Flux @ 175 mA		Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)	
Dovel Plue	D36	450	450 D57	465	11	210	XQAROY-00-0000-000000601
Royal Blue	D30	430		D57 465	12	250	XQAROY-00-0000-000000701

	Dominant Wavelength Range				Minimum Lumino	us Flow @ 175 m A	
Color	Minimim		Maximum		Minimum Luminous Flux @ 175 mA		Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Blue	DO.	465	В6	405	F2	10.7	XQABLU-00-0000-000000T01
blue	B3	465		485	G2	13.9	XQABLU-00-0000-00000000

	Dominant Wavelength Range			Minimum Lumin	Flore @ 17F A													
Color	Minimum Maximum		mum	Minimum Luminous Flux @ 175 mA		Order Code												
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)												
			G4	G4	G4 535	G4 53:	G4	0.4								K2	30.6	XQAGRN-00-0000-000000Y01
	00	F00							535	535	G4 535		35.2	XQAGRN-00-0000-000000Z01				
Green	en G2 520	G4						535				535	535	1 535	535	M2	39.8	XQAGRN-00-0000-000000201
					M3	45.7	XQAGRN-00-0000-000000301											

Color Color Bin	Colon Bin	Minimum Lumino	us Flux @ 175 mA	Order Code
Color	Color Color Bin	Group	Flux (lm)	Order Code
	PC Amber Y2	J3	26.8	XQAAPA-00-0000-000000X01
PC Amber		K2	30.6	XQAAPA-00-0000-000000Y01
		К3	35.2	XQAAPA-00-0000-000000Z01

	Dominant Wavelength Range			Minimum I umin a	Flore @ 175 A											
Color	Minir	Minimum		mum	Minimum Luminous Flux @ 175 mA		Order Code									
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)										
			04	04									K2	K2	30.6	XQARDO-00-0000-000000Y01
Red-Orange	03	610			620	620	K3	35.2	XQARDO-00-0000-000000Z01							
				M2	39.8	XQARDO-00-0000-000000201										



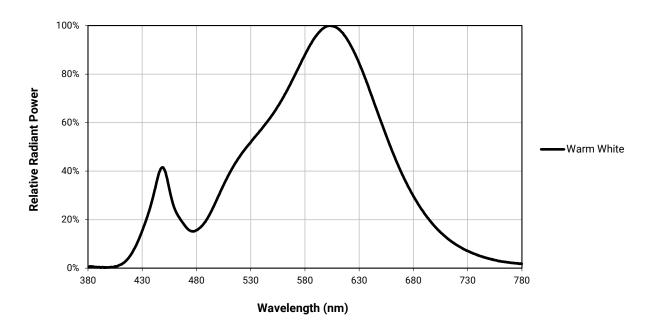
FLUX CHARACTERISTICS - COLOR (T $_{\rm J}$ = 25 °C) - CONTINUED

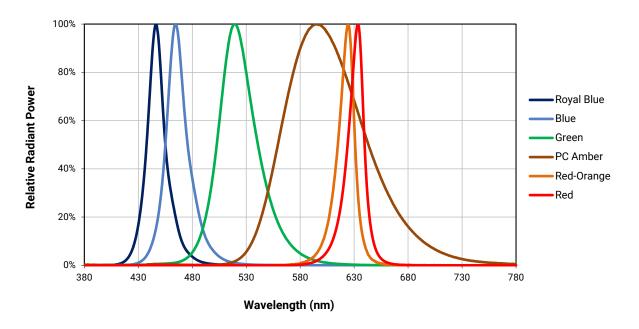
	Doi	minant Wav	elength Ran	ge	Minimum Iin	Flore @ 175 A									
Color	Minir	num	Maxi	mum	Minimum Luminous Flux @ 175 mA				Order Code						
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)									
													J2	23.5	XQARED-00-0000-000000W01
Red	R2	620	R3	R3 630	J3	26.8	XQARED-00-0000-000000X01								
								K2	30.6	XQARED-00-0000-000000Y01					

Note: Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements and ± 1 nm on dominant wavelength measurements. See the Measurements section (page 15).



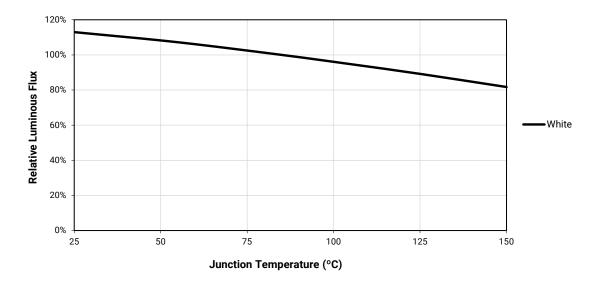
RELATIVE SPECTRAL POWER DISTRIBUTION

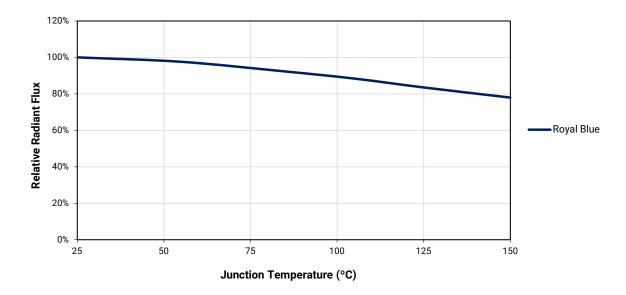






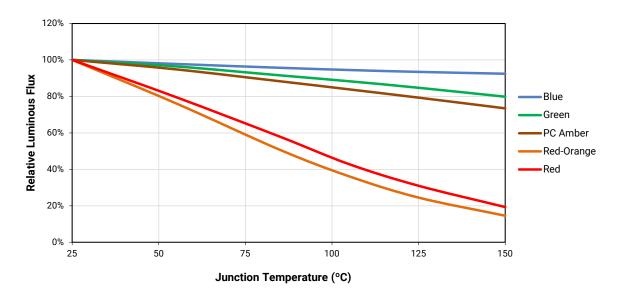
RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 175 mA)



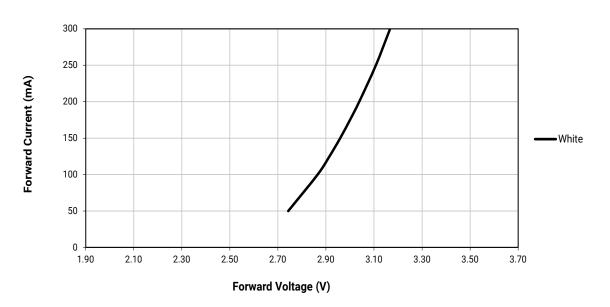




RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 175 mA) - CONTINUED

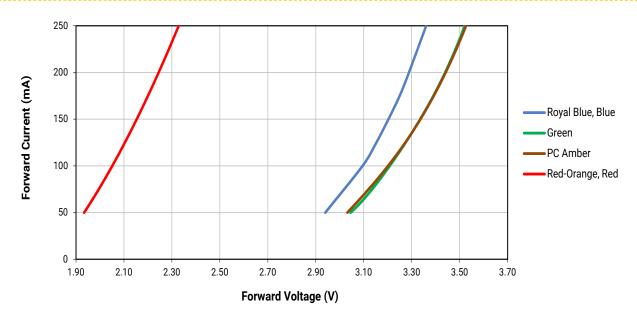


ELECTRICAL CHARACTERISTICS (T, = 85 °C)

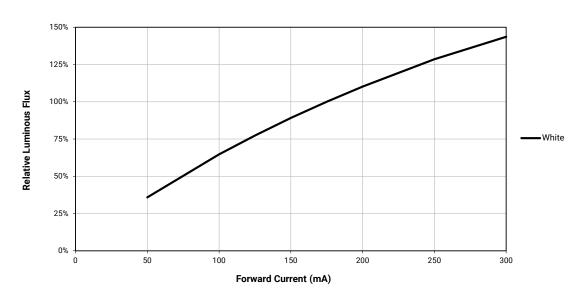




ELECTRICAL CHARACTERISTICS (T₁ = 25 °C)

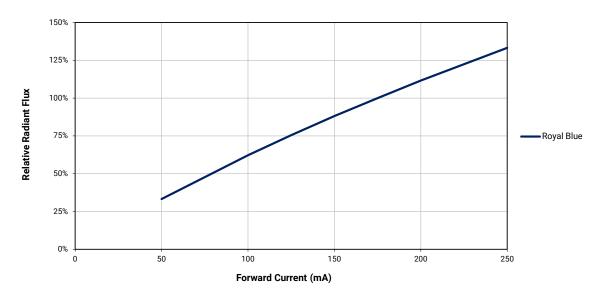


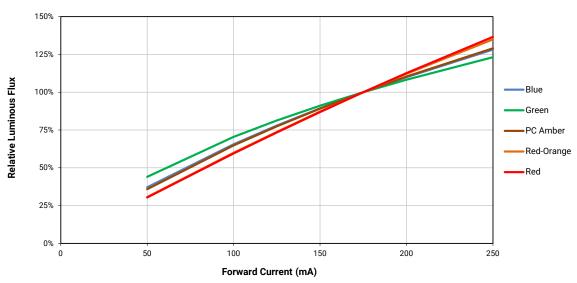
RELATIVE FLUX VS. CURRENT (T₁ = 85 °C)





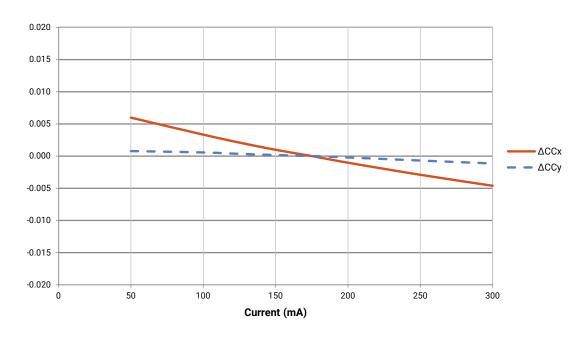
RELATIVE FLUX VS. CURRENT ($T_J = 25$ °C)

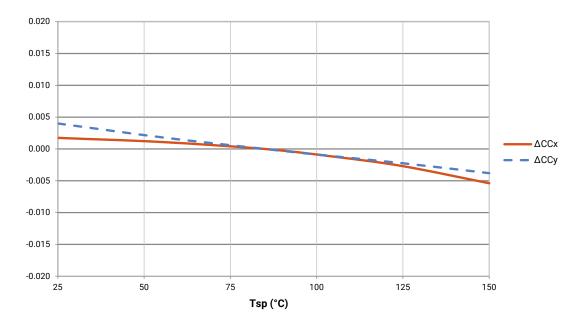






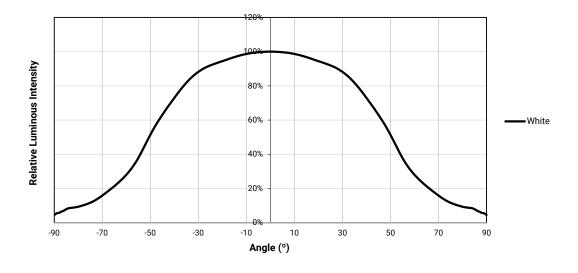
RELATIVE CHROMATICITY VS. CURRENT AND TEMPERATURE (WARM WHITE)

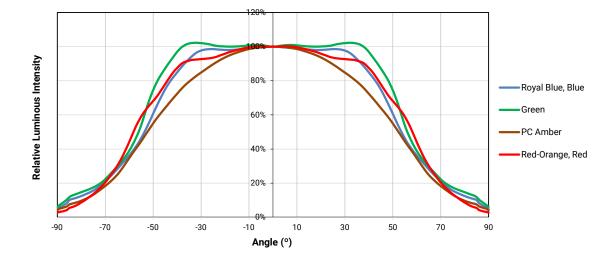






TYPICAL SPATIAL DISTRIBUTION

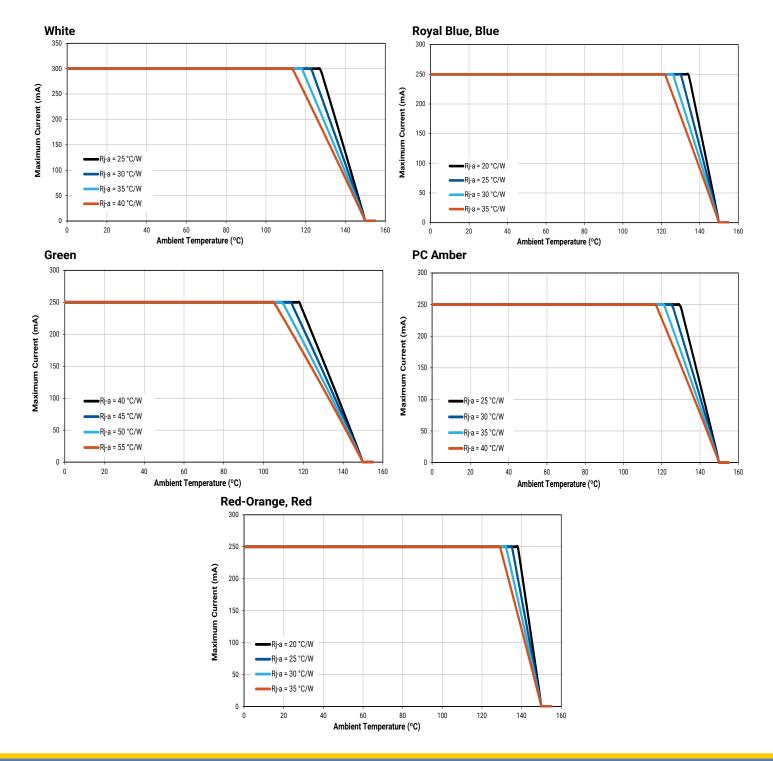






THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

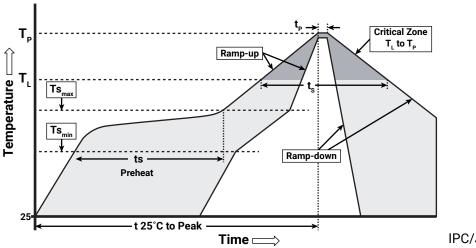




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XQ-A LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T_L)	217 °C
Time Maintained Above: Time (t _L)	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Pre-Release Qualification Testing

Please read the LED Reliability Overview for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs. Cree did not perform Room Temperature Operating Life (RTOL) testing on the XQ-A LED.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XQ-A LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of \leq 30 °C/85% relative humidity (RH). Regardless of storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

UL® Recognized Component

Level 1 enclosure consideration. The LED package or a portion thereof has not been investigated as a fire enclosure or a fire and electrical enclosure per ANSI/UL 8750.



NOTES - CONTINUED

Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

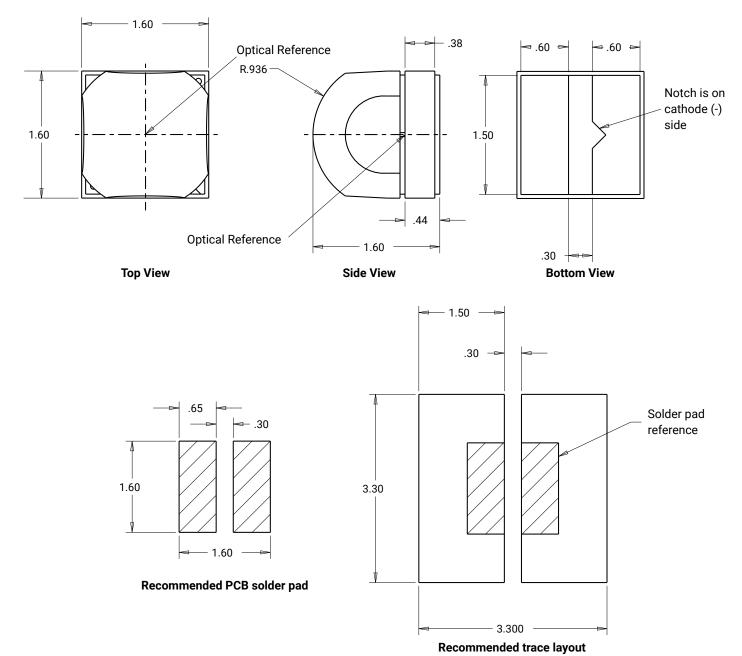


MECHANICAL DIMENSIONS

Thermal vias, if present, are not shown on these drawings.

All dimensions in mm.

Measurement tolerances unless indicated otherwise: ±.13 mm



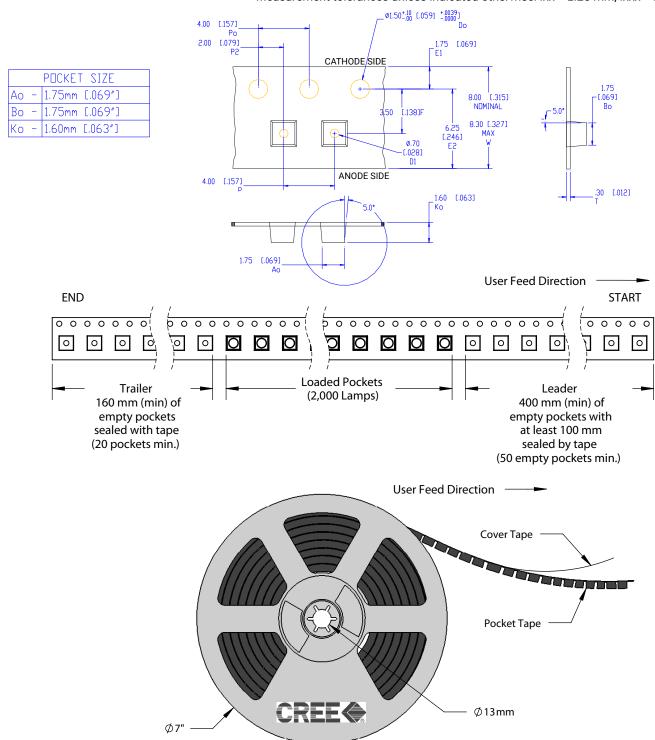


TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

Except as noted, all dimensions in mm [in].

Measurement tolerances unless indicated otherwise: .xx = ±.25 mm, .xxx = . ± 125 mm





PACKAGING

The diagrams below show the packaging and labels Cree uses to ship XLamp XQ-A LEDs. XLamp XQ-A LEDs are shipped in tape loaded on a reel. Each box contains only one reel in a moisture barrier bag.

